

Title (en)

COOLING CIRCUIT FOR AN ELECTRONIC HOUSING, COMPRISING A POWER MODULE

Title (de)

KÜHLKREISLAUF FÜR EIN ELEKTRONISCHES GEHÄUSE MIT EINEM LEISTUNGSMODUL

Title (fr)

CIRCUIT DE REFROIDISSEMENT POUR LOGEMENT ELECTRONIQUE AVEC MODULE DE PUISSANCE

Publication

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Application

EP 21713034 A 20210323

Priority

- FR 2002944 A 20200326
- EP 2021057398 W 20210323

Abstract (en)

[origin: WO2021191193A1] The invention relates to an electronic assembly (100) comprising an electronic housing (1) and a cooling circuit (2), closed by a cover (5), in which a cooling fluid circulates, said cooling circuit (2) comprising primary protuberances (21) on its inner surface (22), and comprising at least one secondary turbulator protuberance (24) on the inner face of the cover (5).

IPC 8 full level

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CPC (source: EP)

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Citation (search report)

See references of WO 2021191193A1

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